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(54) **REACTIVE HOT MELT ADHESIVE COMPOSITION**

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This patent is subject to a terminal disclaimer.

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See application file for complete search history.

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(57) **ABSTRACT**

The present invention relates to a process for preparing a reactive hotmelt adhesive formulation having a low residual content of monomeric diisocyanate. The present invention further provides a reactive hotmelt adhesive composition obtainable by the process of the invention.

10 Claims, No Drawings